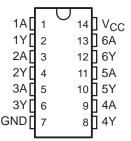
Dependable Texas Instruments Quality and Reliability

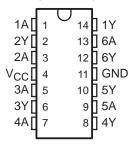
### description/ordering information

These devices contain six independent inverters.

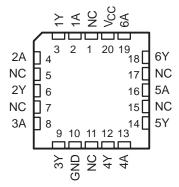
SN5404 ... J PACKAGE
SN54LS04, SN54S04 ... J OR W PACKAGE
SN7404, SN74S04 ... D, N, OR NS PACKAGE
SN74LS04 ... D, DB, N, OR NS PACKAGE
(TOP VIEW)



## SN5404 . . . W PACKAGE (TOP VIEW)



## SN54LS04, SN54S04 ... FK PACKAGE (TOP VIEW)



NC - No internal connection



PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



#### **ORDERING INFORMATION**

| TA             | PAC       | KAGE†         | ORDERABLE<br>PART NUMBER | TOP-SIDE<br>MARKING |
|----------------|-----------|---------------|--------------------------|---------------------|
|                |           | Tube          | SN7404N                  | SN7404N             |
|                | PDIP – N  | Tube          | SN74LS04N                | SN74LS04N           |
|                |           | Tube          | SN74S04N                 | SN74S04N            |
|                |           | Tube          | SN7404D                  | 7404                |
|                |           | Tape and reel | SN7404DR                 | 7404                |
|                | SOIC - D  | Tube          | SN74LS04D                | 1.004               |
| 0°C to 70°C    | SOIC - D  | Tape and reel | SN74LS04DR               | LS04                |
|                |           | Tube          | SN74S04D                 | 004                 |
|                |           | Tape and reel | SN74S04DR                | S04                 |
|                |           | Tape and reel | SN7404NSR                | SN7404              |
|                | SOP - NS  | Tape and reel | SN74LS04NSR              | 74LS04              |
|                |           | Tape and reel | SN74S04NSR               | 74S04               |
|                | SSOP – DB | Tape and reel | SN74LS04DBR              | LS04                |
|                |           | Tube          | SN5404J                  | SN5404J             |
|                |           | Tube          | SNJ5404J                 | SNJ5404J            |
|                | CDIP – J  | Tube          | SN54LS04J                | SN54LS04J           |
|                | CDIP – J  | Tube          | SN54S04J                 | SN54S04J            |
|                |           | Tube          | SNJ54LS04J               | SNJ54LS04J          |
| -55°C to 125°C |           | Tube          | SNJ54S04J                | SNJ54S04J           |
|                |           | Tube          | SNJ5404W                 | SNJ5404W            |
|                | CFP – W   | Tube          | SNJ54LS04W               | SNJ54LS04W          |
|                |           | Tube          | SNJ54S04W                | SNJ54S04W           |
|                | LCCC – FK | Tube          | SNJ54LS04FK              | SNJ54LS04FK         |
|                | LCCC - FK | Tube          | SNJ54S04FK               | SNJ54S04FK          |

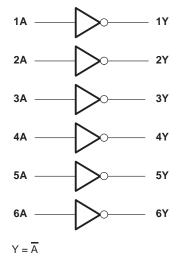
<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

#### **FUNCTION TABLE** (each inverter)

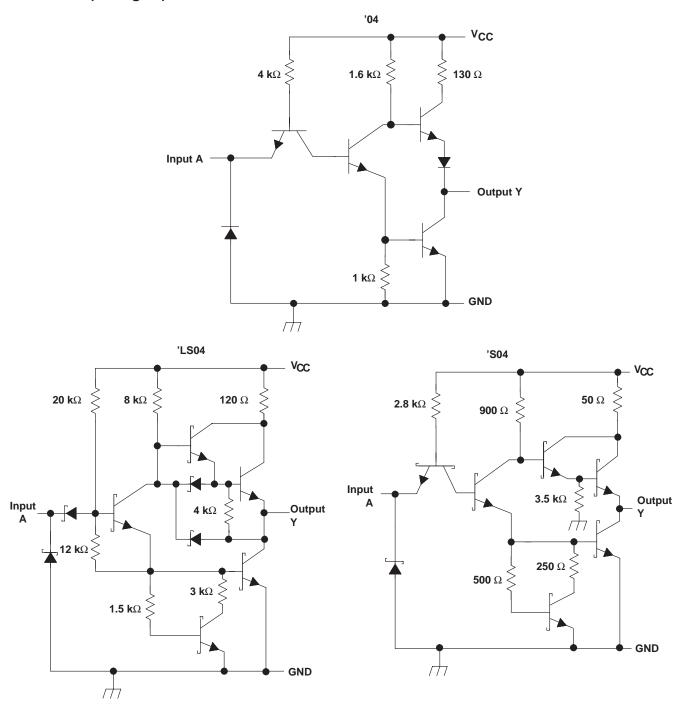
| ` `   | ,      |
|-------|--------|
| INPUT | OUTPUT |
| Α     | Υ      |
| Н     | L      |
| L     | н      |



## logic diagram (positive logic)



### schematics (each gate)



Resistor values shown are nominal.



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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage, V <sub>CC</sub> (see Note 1)           |               |  |
|--|---------------|--|
| Input voltage, V <sub>I</sub> : '04, 'S04              |               |  |
| 'LS04  |               |  |
| Package thermal impedance, θ <sub>JA</sub> (see Note 2 | 2): D package |  |
| -  | DB package    |  |
|  | N package     |  |
|  | NS package    |  |
| Storage temperature range, T <sub>stq</sub>            |               |  |

#### recommended operating conditions (see Note 3)

|                 |                                |     | SN5404 |      | ;    | SN7404 |      | UNIT |
|-----------------|--------------------------------|-----|--------|------|------|--------|------|------|
|                 |                                | MIN | NOM    | MAX  | MIN  | NOM    | MAX  | UNII |
| VCC             | Supply voltage                 | 4.5 | 5      | 5.5  | 4.75 | 5      | 5.25 | V    |
| V <sub>IH</sub> | High-level input voltage       | 2   |        |      | 2    |        |      | V    |
| $V_{IL}$        | Low-level input voltage        |     |        | 0.8  |      |        | 0.8  | V    |
| ІОН             | High-level output current      |     |        | -0.4 |      |        | -0.4 | mA   |
| loL             | Low-level output current       |     |        | 16   |      |        | 16   | mA   |
| TA              | Operating free-air temperature | -55 |        | 125  | 0    |        | 70   | °C   |

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| DADAMETER        |                  | TEGT CONDITIO            |                            |     | SN5404 |      |     | SN7404 |      |      |
|------------------|------------------|--------------------------|----------------------------|-----|--------|------|-----|--------|------|------|
| PARAMETER        |                  | TEST CONDITION           | JNS+                       | MIN | TYP§   | MAX  | MIN | TYP§   | MAX  | UNIT |
| VIK              | $V_{CC} = MIN,$  | $I_{I} = -12 \text{ mA}$ |                            |     |        | -1.5 |     |        | -1.5 | V    |
| Voн              | $V_{CC} = MIN,$  | $V_{IL} = 0.8 V$ ,       | $I_{OH} = -0.4 \text{ mA}$ | 2.4 | 3.4    |      | 2.4 | 3.4    |      | V    |
| VOL              | $V_{CC} = MIN,$  | $V_{IH} = 2 V$ ,         | $I_{OL} = 16 \text{ mA}$   |     | 0.2    | 0.4  |     | 0.2    | 0.4  | V    |
| lį               | $V_{CC} = MAX$ , | V <sub>I</sub> = 5.5 V   |                            |     |        | 1    |     |        | 1    | mA   |
| liΗ              | $V_{CC} = MAX$ , | V <sub>I</sub> = 2.4 V   |                            |     |        | 40   |     |        | 40   | μΑ   |
| I <sub>I</sub> L | $V_{CC} = MAX$ , | V <sub>I</sub> = 0.4 V   |                            |     |        | -1.6 |     |        | -1.6 | mA   |
| los¶             | VCC = MAX        |                          |                            | -20 |        | -55  | -18 |        | -55  | mA   |
| Іссн             | $V_{CC} = MAX$ , | V <sub>I</sub> = 0 V     |                            |     | 6      | 12   |     | 6      | 12   | mA   |
| ICCL             | $V_{CC} = MAX$ , | V <sub>I</sub> = 4.5 V   | -                          |     | 18     | 33   |     | 18     | 33   | mA   |

<sup>‡</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. This are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. Voltage values are with respect to network ground terminal.

<sup>2.</sup> The package thermal impedance is calculated in accordance with JESD 51-7.

<sup>§</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

<sup>¶</sup> Not more than one output should be shorted at a time.

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## switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$ (see Figure 1)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | TEST C               | CONDITIONS             | <i>3, 3,</i> | UNIT |     |    |
|------------------|-----------------|----------------|----------------------|------------------------|--------------|------|-----|----|
|                  | (INFOT)         | (001701)       |                      |                        |              | TYP  | MAX |    |
| <sup>t</sup> PLH | ۸               | V              | P 400 O              | C 15 pE                |              | 12   | 22  | 20 |
| <sup>t</sup> PHL | A               | ſ              | $R_L = 400 \Omega$ , | C <sub>L</sub> = 15 pF |              | 8    | 15  | ns |

#### recommended operating conditions (see Note 3)

|                 |                                | S   | N54LS04 | 4    | S    | N74LS04 | 4    | UNIT |
|-----------------|--------------------------------|-----|---------|------|------|---------|------|------|
|                 |                                | MIN | NOM     | MAX  | MIN  | NOM     | MAX  | UNII |
| VCC             | Supply voltage                 | 4.5 | 5       | 5.5  | 4.75 | 5       | 5.25 | V    |
| $V_{\text{IH}}$ | High-level input voltage       | 2   |         |      | 2    |         |      | V    |
| VIL             | Low-level input voltage        |     |         | 0.7  |      |         | 0.8  | V    |
| ІОН             | High-level output current      |     |         | -0.4 |      |         | -0.4 | mA   |
| lOL             | Low-level output current       |     |         | 4    |      |         | 8    | mA   |
| TA              | Operating free-air temperature | -55 |         | 125  | 0    |         | 70   | °C   |

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                   | TEGT CONDITIONS!                    |                          | S                          | SN54LS04 |                  |      | SN74LS04 |                  |      |      |
|-------------------|-------------------------------------|--------------------------|----------------------------|----------|------------------|------|----------|------------------|------|------|
| PARAMETER         | TEST CONDITIONS†                    |                          |                            | MIN      | TYP <sup>‡</sup> | MAX  | MIN      | TYP <sup>‡</sup> | MAX  | UNIT |
| VIK               | V <sub>CC</sub> = MIN,              | $I_{I} = -18 \text{ mA}$ |                            |          |                  | -1.5 |          |                  | -1.5 | V    |
| Voн               | $V_{CC} = MIN,$                     | $V_{IL} = MAX$ ,         | $I_{OH} = -0.4 \text{ mA}$ | 2.5      | 3.4              |      | 2.7      | 3.4              |      | V    |
|                   | Va a - MINI                         | V 2 V                    | $I_{OL} = 4 \text{ mA}$    |          | 0.25             | 0.4  |          |                  | 0.4  | V    |
| VOL               | $V_{OL}$ $V_{CC} = MIN,$ $V_{IH} =$ | $V_{IH} = 2 V$           | I <sub>OL</sub> = 8 mA     |          |                  |      |          | 0.25             | 0.5  | V    |
| ΙĮ                | $V_{CC} = MAX$ ,                    | V <sub>I</sub> = 7 V     |                            |          |                  | 0.1  |          |                  | 0.1  | mA   |
| lіН               | $V_{CC} = MAX$ ,                    | V <sub>I</sub> = 2.7 V   |                            |          |                  | 20   |          |                  | 20   | μΑ   |
| I <sub>IL</sub>   | $V_{CC} = MAX$ ,                    | V <sub>I</sub> = 0.4 V   |                            |          |                  | -0.4 |          |                  | -0.4 | mA   |
| I <sub>OS</sub> § | VCC = MAX                           | _                        |                            | -20      |                  | -100 | -20      |                  | -100 | mA   |
| ІССН              | $V_{CC} = MAX$ ,                    | V <sub>I</sub> = 0 V     |                            |          | 1.2              | 2.4  |          | 1.2              | 2.4  | mA   |
| ICCL              | $V_{CC} = MAX$ ,                    | V <sub>I</sub> = 4.5 V   |                            |          | 3.6              | 6.6  |          | 3.6              | 6.6  | mA   |

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

## switching characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C (see Figure 2)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | TEST CONDITIONS |                                 |     | N54LS04<br>N74LS04 |     | UNIT |
|------------------|-----------------|----------------|-----------------|---------------------------------|-----|--------------------|-----|------|
|                  | (IIVI O1)       | (0011 01)      |                 |                                 | MIN | TYP                | MAX |      |
| t <sub>PLH</sub> | ^               | V              | D. 210          | C: 45 pF                        |     | 9                  | 15  |      |
| <sup>t</sup> PHL | А               | Ť              | RL = 2  KS2,    | $L = 2 k\Omega$ , $C_L = 15 pF$ |     | 10                 | 15  | ns   |



<sup>‡</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

<sup>§</sup> Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

#### recommended operating conditions (see Note 3)

|     |                                | 8   | N54S04 |     | 9    | N74S04 |      | LINUT |
|-----|--------------------------------|-----|--------|-----|------|--------|------|-------|
|     |                                | MIN | NOM    | MAX | MIN  | NOM    | MAX  | UNIT  |
| VCC | Supply voltage                 | 4.5 | 5      | 5.5 | 4.75 | 5      | 5.25 | V     |
| VIH | High-level input voltage       | 2   |        |     | 2    |        |      | V     |
| VIL | Low-level input voltage        |     |        | 8.0 |      |        | 8.0  | V     |
| lOH | High-level output current      |     |        | -1  |      |        | -1   | mA    |
| lOL | Low-level output current       |     |        | 20  |      |        | 20   | mA    |
| TA  | Operating free-air temperature | -55 |        | 125 | 0    |        | 70   | °C    |

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| 24244555         |                  |                          |                          | (   | SN54S04 |      |     | N74S04 |      |      |
|------------------|------------------|--------------------------|--------------------------|-----|---------|------|-----|--------|------|------|
| PARAMETER        |                  | TEST CONDITION           | ONSI                     | MIN | TYP‡    | MAX  | MIN | TYP‡   | MAX  | UNIT |
| VIK              | $V_{CC} = MIN,$  | $I_{I} = -18 \text{ mA}$ |                          |     |         | -1.2 |     |        | -1.2 | V    |
| Voн              | $V_{CC} = MIN,$  | $V_{IL} = 0.8 V$ ,       | $I_{OH} = -1 \text{ mA}$ | 2.5 | 3.4     |      | 2.7 | 3.4    |      | V    |
| VOL              | $V_{CC} = MIN,$  | V <sub>IH</sub> = 2 V,   | $I_{OL} = 20 \text{ mA}$ |     |         | 0.5  |     |        | 0.5  | V    |
| ΙĮ               | $V_{CC} = MAX$ , | V <sub>I</sub> = 5.5 V   |                          |     |         | 1    |     |        | 1    | mA   |
| lН               | $V_{CC} = MAX$ , | V <sub>I</sub> = 2.7 V   |                          |     |         | 50   |     |        | 50   | μΑ   |
| Ι <sub>Ι</sub> L | $V_{CC} = MAX$ , | V <sub>I</sub> = 0.5 V   |                          |     |         | -2   |     |        | -2   | mA   |
| los§             | $V_{CC} = MAX$   |                          |                          | -40 |         | -100 | -40 |        | -100 | mA   |
| Іссн             | $V_{CC} = MAX$ , | V <sub>I</sub> = 0 V     |                          |     | 15      | 24   |     | 15     | 24   | mA   |
| ICCL             | $V_{CC} = MAX$ , | V <sub>I</sub> = 4.5 V   | -                        |     | 30      | 54   |     | 30     | 54   | mA   |

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

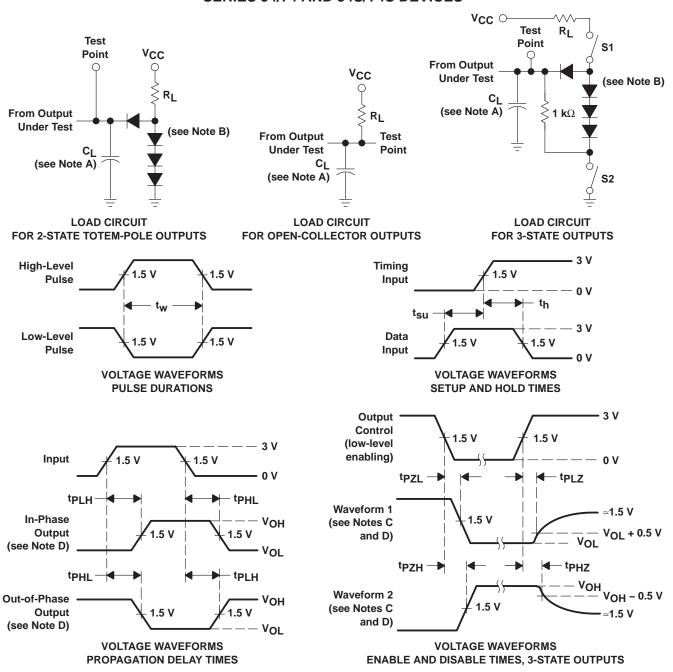
## switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$ (see Figure 1)

| PARAMETER        | PARAMETER FROM TO TEST CONDITIONS |          | CONDITIONS         | S<br>S                 |     | UNIT |     |     |
|------------------|-----------------------------------|----------|--------------------|------------------------|-----|------|-----|-----|
|                  | (INFOT)                           | (001F01) |                    |                        | MIN | TYP  | MAX |     |
| <sup>t</sup> PLH | ۸                                 | V        | $R_1 = 280 \Omega$ | C <sub>I</sub> = 15 pF |     | 3    | 4.5 | ns  |
| tPHL             | A                                 | '        | KL = 200 sz,       | OL = 13 pr             |     | 3    | 5   | 115 |
| tPLH .           | ۸                                 | V        | $R_1 = 280 \Omega$ | C: - 50 pE             |     | 4.5  |     | ns  |
| <sup>t</sup> PHL | А                                 | r        | NL = 200 22,       | C <sub>L</sub> = 50 pF |     | 5    |     | 115 |

<sup>‡</sup> All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

<sup>§</sup> Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

# PARAMETER MEASUREMENT INFORMATION SERIES 54/74 AND 54S/74S DEVICES



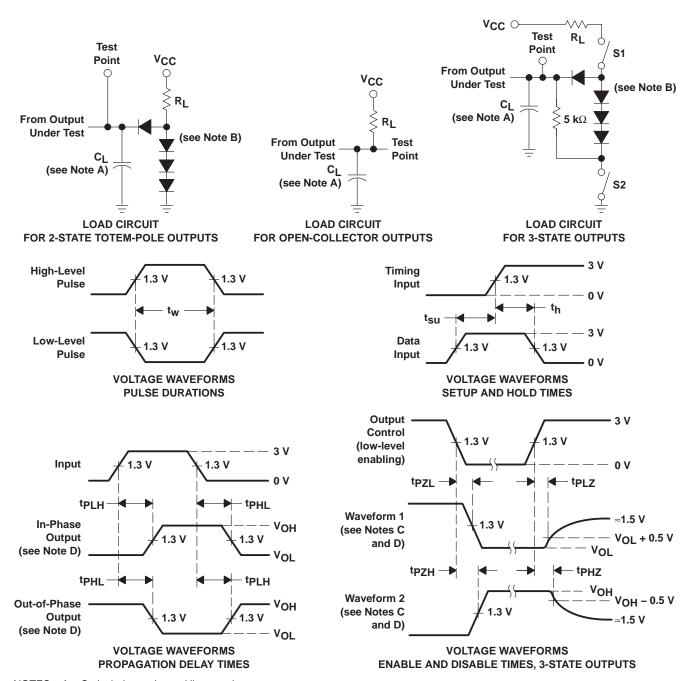
NOTES: A.  $C_L$  includes probe and jig capacitance.

- B. All diodes are 1N3064 or equivalent.
- C. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- D. S1 and S2 are closed for tpLH, tpHZ, and tpLZ; S1 is open and S2 is closed for tpZH; S1 is closed and S2 is open for tpZL.
- E. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O \approx 50~\Omega$ ;  $t_r$  and  $t_f \leq$  7 ns for Series 54/74 devices and  $t_r$  and  $t_f \leq$  2.5 ns for Series 54S/74S devices.
- F. The outputs are measured one at a time, with one input transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms



# PARAMETER MEASUREMENT INFORMATION SERIES 54LS/74LS DEVICES



- NOTES: A.  $C_L$  includes probe and jig capacitance.
  - B. All diodes are 1N3064 or equivalent.
  - C. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
  - D. S1 and S2 are closed for tpLH, tpHL, tpHZ, and tpLZ; S1 is open and S2 is closed for tpZH; S1 is closed and S2 is open for tpZL.
  - E. Phase relationships between inputs and outputs have been chosen arbitrarily for these examples.
  - F. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O \approx 50 \ \Omega$ ,  $t_f \leq$  1.5 ns,  $t_f \leq$  2.6 ns.
  - G. The outputs are measured one at a time, with one input transition per measurement.

Figure 2. Load Circuits and Voltage Waveforms







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### **PACKAGING INFORMATION**

| Orderable<br>part number | Status (1) | Material type | Package   Pins | Package qty   Carrier | <b>RoHS</b> (3) | Lead finish/<br>Ball material | MSL rating/<br>Peak reflow | Op temp (°C) | Part marking (6)     |
|--------------------------|------------|---------------|----------------|-----------------------|-----------------|-------------------------------|----------------------------|--------------|----------------------|
| JM38510/00105BCA         | Active     | Production    | CDIP (J)   14  | 25   TUBE             | No              | SNPB                          | N/A for Pkg Type           | -55 to 125   | JM38510/<br>00105BCA |
| JM38510/00105BDA         | Active     | Production    | CFP (W)   14   | 25   TUBE             | No              | SNPB                          | N/A for Pkg Type           | -55 to 125   | JM38510/<br>00105BDA |
| JM38510/07003BCA         | Active     | Production    | CDIP (J)   14  | 25   TUBE             | No              | SNPB                          | N/A for Pkg Type           | -55 to 125   | JM38510/<br>07003BCA |
| JM38510/07003BDA         | Active     | Production    | CFP (W)   14   | 25   TUBE             | No              | SNPB                          | N/A for Pkg Type           | -55 to 125   | JM38510/<br>07003BDA |
| JM38510/30003B2A         | Active     | Production    | LCCC (FK)   20 | 55   TUBE             | No              | SNPB                          | N/A for Pkg Type           | -55 to 125   | JM38510/<br>30003B2A |
| JM38510/30003BCA         | Active     | Production    | CDIP (J)   14  | 25   TUBE             | No              | SNPB                          | N/A for Pkg Type           | -55 to 125   | JM38510/<br>30003BCA |
| JM38510/30003BDA         | Active     | Production    | CFP (W)   14   | 25   TUBE             | No              | SNPB                          | N/A for Pkg Type           | -55 to 125   | JM38510/<br>30003BDA |
| JM38510/30003SCA         | Active     | Production    | CDIP (J)   14  | 25   TUBE             | No              | SNPB                          | N/A for Pkg Type           | -55 to 125   | JM38510/<br>30003SCA |
| SN5404J                  | Active     | Production    | CDIP (J)   14  | 25   TUBE             | No              | SNPB                          | N/A for Pkg Type           | -55 to 125   | SN5404J              |
| SN54LS04J                | Active     | Production    | CDIP (J)   14  | 25   TUBE             | No              | SNPB                          | N/A for Pkg Type           | -55 to 125   | SN54LS04J            |
| SN54S04J                 | Active     | Production    | CDIP (J)   14  | 25   TUBE             | No              | SNPB                          | N/A for Pkg Type           | -55 to 125   | SN54S04J             |
| SN7404D                  | Obsolete   | Production    | SOIC (D)   14  | -                     | -               | Call TI                       | Call TI                    | 0 to 70      | 7404                 |
| SN7404DR                 | Active     | Production    | SOIC (D)   14  | 2500   LARGE T&R      | Yes             | NIPDAU                        | Level-1-260C-UNLIM         | 0 to 70      | 7404                 |
| SN7404N                  | Active     | Production    | PDIP (N)   14  | 25   TUBE             | Yes             | NIPDAU                        | N/A for Pkg Type           | 0 to 70      | SN7404N              |
| SN74LS04D                | Active     | Production    | SOIC (D)   14  | 50   TUBE             | Yes             | NIPDAU                        | Level-1-260C-UNLIM         | 0 to 70      | LS04                 |
| SN74LS04DBR              | Active     | Production    | SSOP (DB)   14 | 2000   LARGE T&R      | Yes             | NIPDAU                        | Level-1-260C-UNLIM         | -            | LS04                 |
| SN74LS04DG4              | Active     | Production    | SOIC (D)   14  | 50   TUBE             | Yes             | NIPDAU                        | Level-1-260C-UNLIM         | 0 to 70      | LS04                 |
| SN74LS04DR               | Active     | Production    | SOIC (D)   14  | 2500   LARGE T&R      | Yes             | NIPDAU                        | Level-1-260C-UNLIM         | 0 to 70      | LS04                 |
| SN74LS04DRG4             | Active     | Production    | SOIC (D)   14  | 2500   LARGE T&R      | Yes             | NIPDAU                        | Level-1-260C-UNLIM         | 0 to 70      | LS04                 |
| SN74LS04N                | Active     | Production    | PDIP (N)   14  | 25   TUBE             | Yes             | NIPDAU                        | N/A for Pkg Type           | 0 to 70      | SN74LS04N            |
| SN74LS04NSR              | Active     | Production    | SOP (NS)   14  | 2000   LARGE T&R      | Yes             | NIPDAU                        | Level-1-260C-UNLIM         | 0 to 70      | 74LS04               |
| SN74S04D                 | Obsolete   | Production    | SOIC (D)   14  | -                     | -               | Call TI                       | Call TI                    | 0 to 70      | S04                  |
| SN74S04DR                | Active     | Production    | SOIC (D)   14  | 2500   LARGE T&R      | Yes             | NIPDAU                        | Level-1-260C-UNLIM         | 0 to 70      | S04                  |



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| Orderable part number | Status | Material type | Package   Pins | Package qty   Carrier | RoHS | Lead finish/<br>Ball material | MSL rating/<br>Peak reflow | Op temp (°C) | Part marking (6) |
|-----------------------|--------|---------------|----------------|-----------------------|------|-------------------------------|----------------------------|--------------|------------------|
|                       |        |               |                |                       |      | (4)                           | (5)                        |              |                  |
| SN74S04N              | Active | Production    | PDIP (N)   14  | 25   TUBE             | Yes  | NIPDAU                        | N/A for Pkg Type           | 0 to 70      | SN74S04N         |
| SN74S04NSR            | Active | Production    | SOP (NS)   14  | 2000   LARGE T&R      | Yes  | NIPDAU                        | Level-1-260C-UNLIM         | 0 to 70      | 74S04            |
| SNJ5404J              | Active | Production    | CDIP (J)   14  | 25   TUBE             | No   | SNPB                          | N/A for Pkg Type           | -55 to 125   | SNJ5404J         |
| SNJ5404W              | Active | Production    | CFP (W)   14   | 25   TUBE             | No   | SNPB                          | N/A for Pkg Type           | -55 to 125   | SNJ5404W         |
| SNJ54LS04FK           | Active | Production    | LCCC (FK)   20 | 55   TUBE             | No   | SNPB                          | N/A for Pkg Type           | -55 to 125   | SNJ54LS<br>04FK  |
| SNJ54LS04J            | Active | Production    | CDIP (J)   14  | 25   TUBE             | No   | SNPB                          | N/A for Pkg Type           | -55 to 125   | SNJ54LS04J       |
| SNJ54LS04W            | Active | Production    | CFP (W)   14   | 25   TUBE             | No   | SNPB                          | N/A for Pkg Type           | -55 to 125   | SNJ54LS04W       |
| SNJ54S04FK            | Active | Production    | LCCC (FK)   20 | 55   TUBE             | No   | SNPB                          | N/A for Pkg Type           | -55 to 125   | SNJ54S<br>04FK   |
| SNJ54S04J             | Active | Production    | CDIP (J)   14  | 25   TUBE             | No   | SNPB                          | N/A for Pkg Type           | -55 to 125   | SNJ54S04J        |
| SNJ54S04W             | Active | Production    | CFP (W)   14   | 25   TUBE             | No   | SNPB                          | N/A for Pkg Type           | -55 to 125   | SNJ54S04W        |

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

### **PACKAGE OPTION ADDENDUM**

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continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

#### OTHER QUALIFIED VERSIONS OF SN5404, SN54LS04, SN54LS04-SP, SN54S04, SN7404, SN74LS04, SN74S04:

Catalog: SN7404, SN74LS04, SN54LS04, SN74S04

Military: SN5404, SN54LS04, SN54S04

• Space : SN54LS04-SP

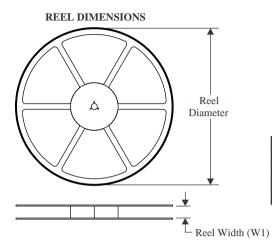
NOTE: Qualified Version Definitions:

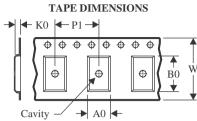
- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications
- Space Radiation tolerant, ceramic packaging and qualified for use in Space-based application

## **PACKAGE MATERIALS INFORMATION**

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#### TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width     |
|----|---|
| В0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

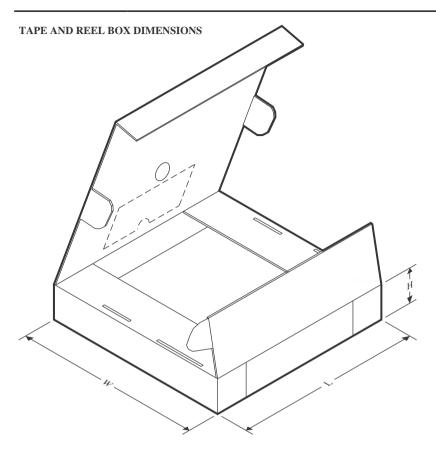


#### \*All dimensions are nominal

| Device      | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|-------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN7404DR    | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| SN74LS04DBR | SSOP            | DB                 | 14 | 2000 | 330.0                    | 16.4                     | 8.35       | 6.6        | 2.4        | 12.0       | 16.0      | Q1               |
| SN74LS04DR  | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| SN74LS04NSR | SOP             | NS                 | 14 | 2000 | 330.0                    | 16.4                     | 8.2        | 10.5       | 2.5        | 12.0       | 16.0      | Q1               |
| SN74LS04NSR | SOP             | NS                 | 14 | 2000 | 330.0                    | 16.4                     | 8.2        | 10.5       | 2.5        | 12.0       | 16.0      | Q1               |
| SN74S04DR   | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| SN74S04NSR  | SOP             | NS                 | 14 | 2000 | 330.0                    | 16.4                     | 8.2        | 10.5       | 2.5        | 12.0       | 16.0      | Q1               |



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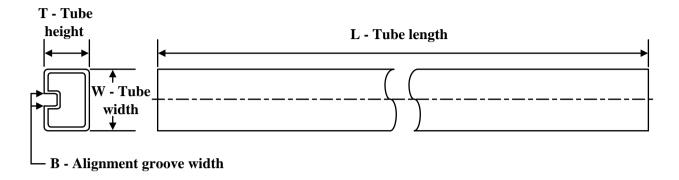
#### \*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN7404DR    | SOIC         | D               | 14   | 2500 | 356.0       | 356.0      | 35.0        |
| SN74LS04DBR | SSOP         | DB              | 14   | 2000 | 356.0       | 356.0      | 35.0        |
| SN74LS04DR  | SOIC         | D               | 14   | 2500 | 356.0       | 356.0      | 35.0        |
| SN74LS04NSR | SOP          | NS              | 14   | 2000 | 353.0       | 353.0      | 32.0        |
| SN74LS04NSR | SOP          | NS              | 14   | 2000 | 356.0       | 356.0      | 35.0        |
| SN74S04DR   | SOIC         | D               | 14   | 2500 | 356.0       | 356.0      | 35.0        |
| SN74S04NSR  | SOP          | NS              | 14   | 2000 | 356.0       | 356.0      | 35.0        |



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#### **TUBE**



\*All dimensions are nominal

| Device           | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|------------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| JM38510/00105BDA | W            | CFP          | 14   | 25  | 506.98 | 26.16  | 6220   | NA     |
| JM38510/07003BDA | W            | CFP          | 14   | 25  | 506.98 | 26.16  | 6220   | NA     |
| JM38510/30003B2A | FK           | LCCC         | 20   | 55  | 506.98 | 12.06  | 2030   | NA     |
| JM38510/30003BDA | W            | CFP          | 14   | 25  | 506.98 | 26.16  | 6220   | NA     |
| M38510/00105BDA  | W            | CFP          | 14   | 25  | 506.98 | 26.16  | 6220   | NA     |
| M38510/07003BDA  | W            | CFP          | 14   | 25  | 506.98 | 26.16  | 6220   | NA     |
| M38510/30003B2A  | FK           | LCCC         | 20   | 55  | 506.98 | 12.06  | 2030   | NA     |
| M38510/30003BDA  | W            | CFP          | 14   | 25  | 506.98 | 26.16  | 6220   | NA     |
| SN7404N          | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| SN7404N          | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| SN7404NE4        | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| SN7404NE4        | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| SN74LS04D        | D            | SOIC         | 14   | 50  | 506.6  | 8      | 3940   | 4.32   |
| SN74LS04DG4      | D            | SOIC         | 14   | 50  | 506.6  | 8      | 3940   | 4.32   |
| SN74LS04N        | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| SN74LS04N        | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| SN74LS04NE4      | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| SN74LS04NE4      | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| SN74S04N         | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| SN74S04N         | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| SN74S04NE4       | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| SN74S04NE4       | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| SNJ5404W         | W            | CFP          | 14   | 25  | 506.98 | 26.16  | 6220   | NA     |
| SNJ54LS04FK      | FK           | LCCC         | 20   | 55  | 506.98 | 12.06  | 2030   | NA     |
| SNJ54LS04W       | W            | CFP          | 14   | 25  | 506.98 | 26.16  | 6220   | NA     |
| SNJ54S04FK       | FK           | LCCC         | 20   | 55  | 506.98 | 12.06  | 2030   | NA     |



SMALL OUTLINE INTEGRATED CIRCUIT



- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm, per side.
- 5. Reference JEDEC registration MS-012, variation AB.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



### **MECHANICAL DATA**

## NS (R-PDSO-G\*\*)

## 14-PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE

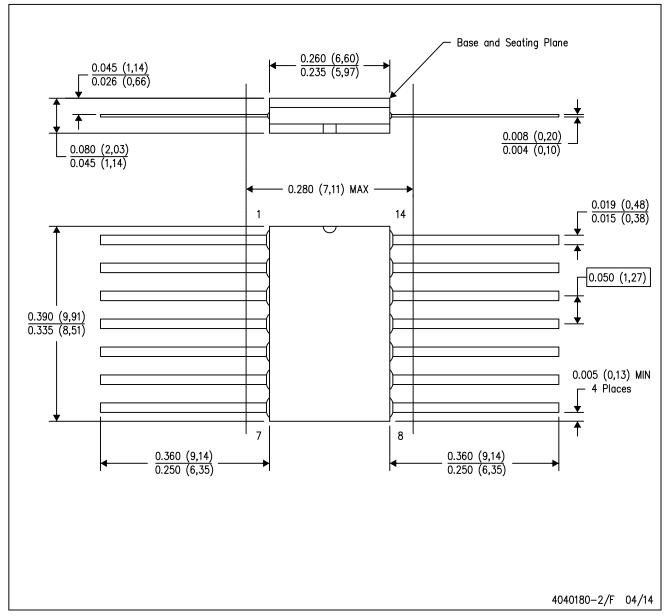


- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



## W (R-GDFP-F14)

## CERAMIC DUAL FLATPACK

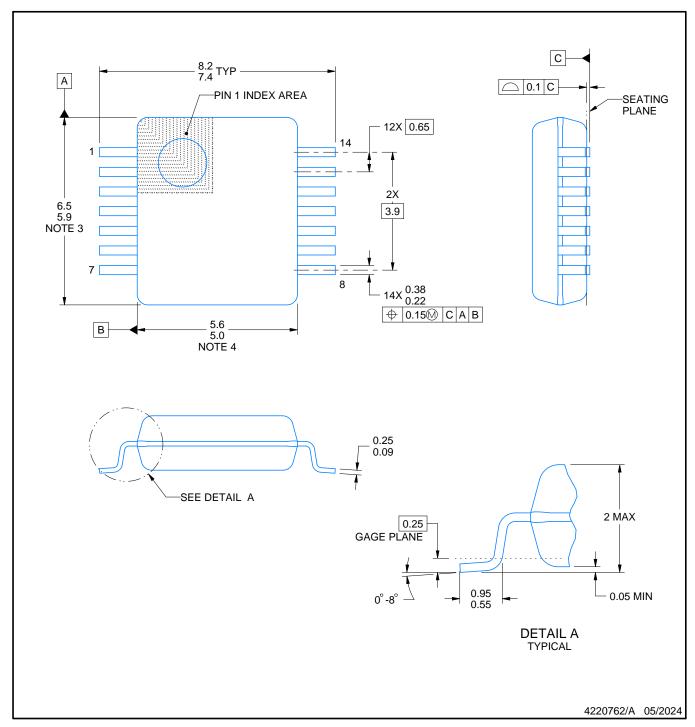


- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14





SMALL OUTLINE PACKAGE



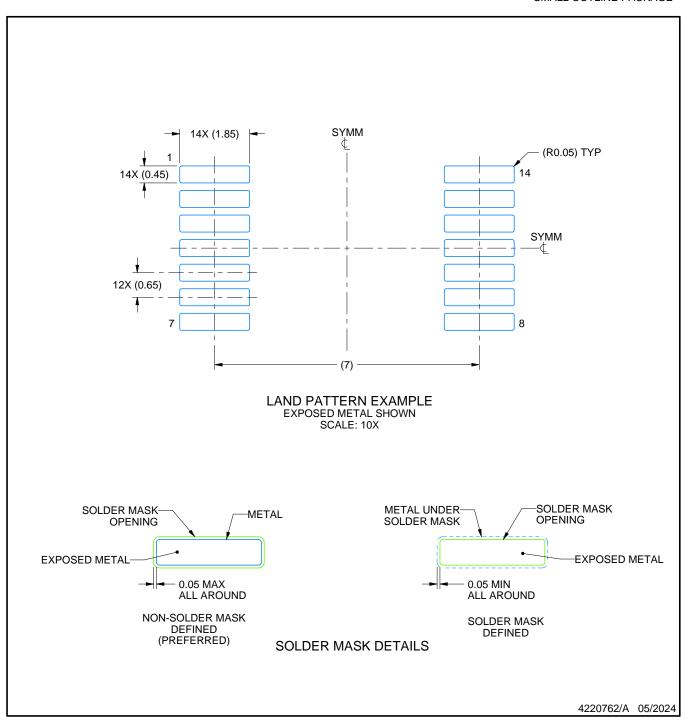
- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
  4. Reference JEDEC registration MO-150.



SMALL OUTLINE PACKAGE

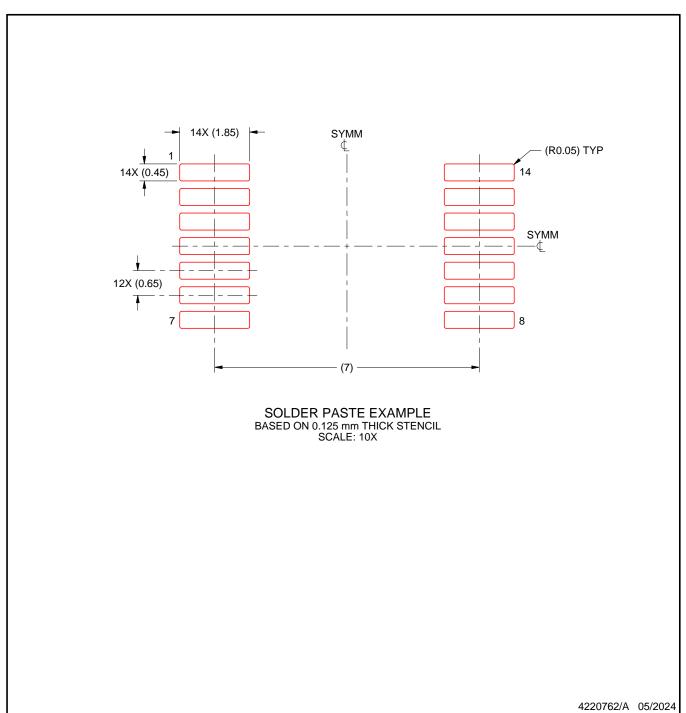


NOTES: (continued)

- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE PACKAGE



NOTES: (continued)

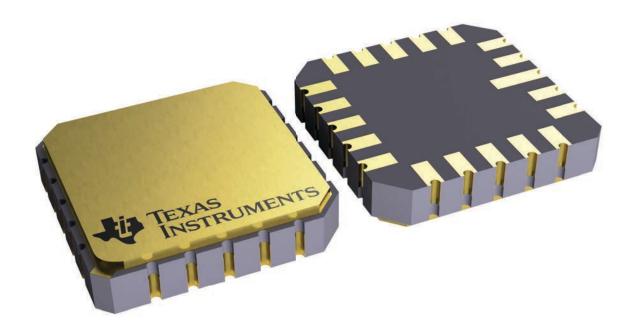
- 7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 8. Board assembly site may have different recommendations for stencil design.



8.89 x 8.89, 1.27 mm pitch

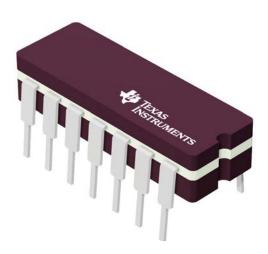
LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



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CERAMIC DUAL IN LINE PACKAGE



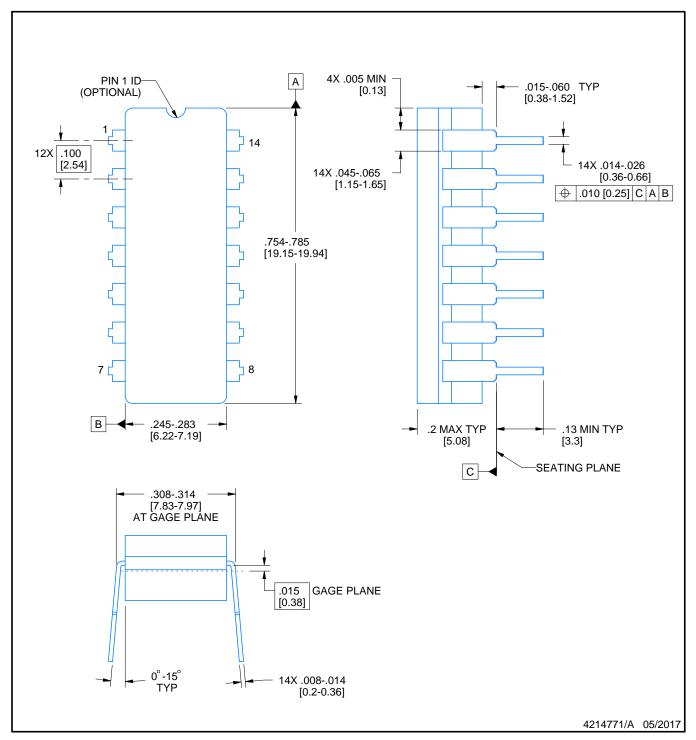
Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4040083-5/G





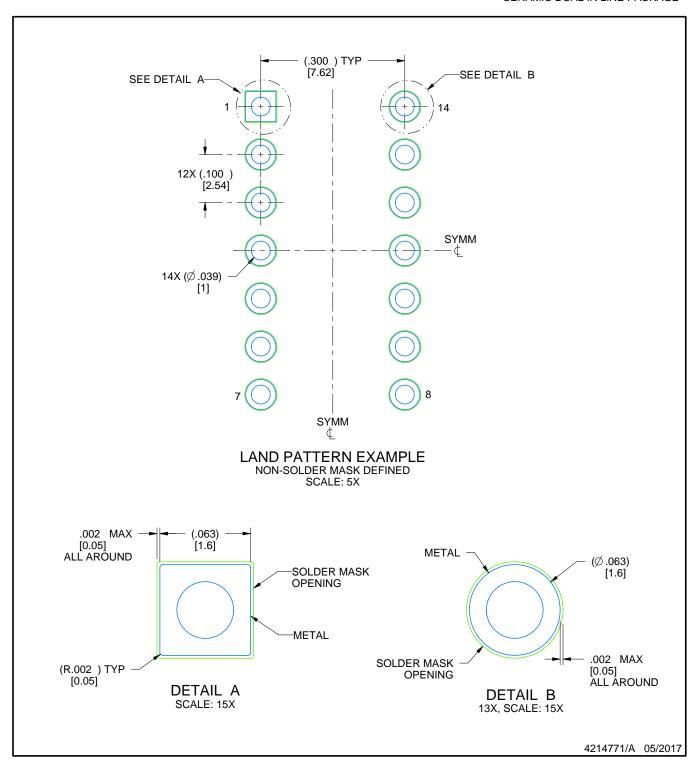
CERAMIC DUAL IN LINE PACKAGE



- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- His package is remitted by sealed with a ceramic its using glass mit.
   Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
   Falls within MIL-STD-1835 and GDIP1-T14.



CERAMIC DUAL IN LINE PACKAGE



## N (R-PDIP-T\*\*)

## PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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